

SN54AHC245, SN74AHC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCLS230I – OCTOBER 1995 – REVISED JULY 2003

- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17

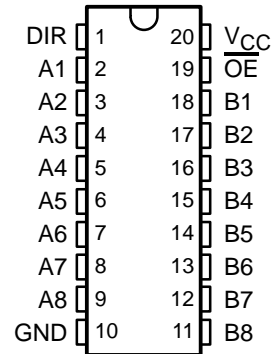
description/ordering information

The 'AHC245 octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

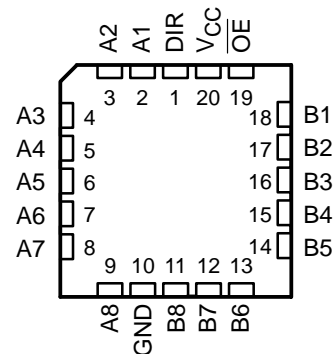
These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54AHC245 . . . J OR W PACKAGE SN74AHC245 . . . DB, DGV, DW, N, OR PW PACKAGE (TOP VIEW)



SN54AHC245 . . . FK PACKAGE (TOP VIEW)



ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube	SN74AHC245N	SN74AHC245N
	SOIC – DW	Tube	SN74AHC245DW	AHC245
		Tape and reel	SN74AHC245DWR	
	SSOP – DB	Tape and reel	SN74AHC245DBR	HA245
	TSSOP – PW	Tube	SN74AHC245PW	HA245
		Tape and reel	SN74AHC245PWR	
	TVSOP – DGV	Tape and reel	SN74AHC245DGVR	HA245
-55°C to 125°C	CDIP – J	Tube	SNJ54AHC245J	SNJ54AHC245J
	CFP – W	Tube	SNJ54AHC245W	SNJ54AHC245W
	LCCC – FK	Tube	SNJ54AHC245FK	SNJ54AHC245FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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 **TEXAS
INSTRUMENTS**

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recommended operating conditions (see Note 3)

		SN54AHC245		SN74AHC245		UNIT
		MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage	2	5.5	2	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 2 V		1.5	1.5	V
		V _{CC} = 3 V		2.1	2.1	
		V _{CC} = 5.5 V		3.85	3.85	
V _{IL}	Low-level input voltage	V _{CC} = 2 V		0.5	0.5	V
		V _{CC} = 3 V		0.9	0.9	
		V _{CC} = 5.5 V		1.65	1.65	
V _I	Input voltage	\overline{OE} or DIR		0	5.5	V
V _O	Output voltage	A or B		0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2 V		-50		μA
		V _{CC} = 3.3 V ± 0.3 V		-4		mA
		V _{CC} = 5 V ± 0.5 V		-8		mA
I _{OL}	Low-level output current	V _{CC} = 2 V		50		μA
		V _{CC} = 3.3 V ± 0.3 V		4		mA
		V _{CC} = 5 V ± 0.5 V		8		
Δt/Δv	Input transition rise or fall rate	V _{CC} = 3.3 V ± 0.3 V		100		ns/V
		V _{CC} = 5 V ± 0.5 V		20		
T _A	Operating free-air temperature	-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	T _A = 25°C			SN54AHC245		SN74AHC245		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{OH}	I _{OH} = -50 μA	2 V	1.9	2		1.9		1.9	V	
		3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
		4.5 V	3.94			3.8		3.8		
V _{OL}	I _{OL} = 50 μA	2 V				0.1		0.1	V	
		3 V				0.1		0.1		
		4.5 V				0.1		0.1		
	I _{OL} = 4 mA	3 V				0.36		0.44		
		4.5 V				0.36		0.44		
I _I	A or B inputs	V _I = V _{CC} or GND	5.5 V			±0.1		±1	μA	
	\overline{OE} or DIR		0 V to 5.5 V			±0.1		±1*		
I _{OZ} [†]	V _O = V _{CC} or GND, V _I (\overline{OE}) = V _{IL} or V _{IH}	5.5 V			±0.25		±2.5	±2.5	μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V			4		40	40	μA	
C _i	\overline{OE} or DIR	V _I = V _{CC} or GND	5 V		2.5	10		10	pF	
C _{io}	A or B inputs	V _I = V _{CC} or GND	5 V		4				pF	

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.

† The parameter I_{OZ} includes the input leakage current.



SN54AHC245, SN74AHC245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54AHC245		SN74AHC245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A or B	B or A	$C_L = 15\text{ pF}$	5.8**	8.4**	1**	10**	1	10	ns	
t_{PHL}				5.8**	8.4**	1**	10**	1	10		
t_{PZH}	\overline{OE}	A or B	$C_L = 15\text{ pF}$	8.5**	13.2**	1**	15.5**	1	15.5	ns	
t_{PZL}				8.5**	13.2**	1**	15.5**	1	15.5		
t_{PHZ}	\overline{OE}	A or B	$C_L = 15\text{ pF}$	8.9**	12.5**	1**	15.5**	1	15.5	ns	
t_{PLZ}				8.9**	12.5**	1**	15.5**	1	15.5		
t_{PLH}	A or B	B or A	$C_L = 50\text{ pF}$	8.3	11.9	1	13.5	1	13.5	ns	
t_{PHL}				8.3	11.9	1	13.5	1	13.5		
t_{PZH}	\overline{OE}	A or B	$C_L = 50\text{ pF}$	11	16.7	1	19	1	19	ns	
t_{PZL}				11	16.7	1	19	1	19		
t_{PHZ}	\overline{OE}	A or B	$C_L = 50\text{ pF}$	11.5	15.8	1	18	1	18	ns	
t_{PLZ}				11.5	15.8	1	18	1	18		
$t_{sk(o)}$			$C_L = 50\text{ pF}$		1.5**				1.5	ns	

** On products compliant to MIL-PRF-38535, this parameter is not production tested.

*** On products compliant to MIL-PRF-38535, this parameter does not apply.

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54AHC245		SN74AHC245		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A or B	B or A	$C_L = 15\text{ pF}$	4*	5.5*	1*	6.5*	1	6.5	ns	
t_{PHL}				4*	5.5*	1*	6.5*	1	6.5		
t_{PZH}	\overline{OE}	A or B	$C_L = 15\text{ pF}$	5.8*	8.5*	1*	10*	1	10	ns	
t_{PZL}				5.8*	8.5*	1*	10*	1	10		
t_{PHZ}	\overline{OE}	A or B	$C_L = 15\text{ pF}$	5.6*	7.8*	1*	9.2*	1	9.2	ns	
t_{PLZ}				5.6*	7.8*	1*	9.2*	1	9.2		
t_{PLH}	A or B	B or A	$C_L = 50\text{ pF}$	5.5	7.5	1	8.5	1	8.5	ns	
t_{PHL}				5.5	7.5	1	8.5	1	8.5		
t_{PZH}	\overline{OE}	A or B	$C_L = 50\text{ pF}$	7.3	10.6	1	12	1	12	ns	
t_{PZL}				7.3	10.6	1	12	1	12		
t_{PHZ}	\overline{OE}	A or B	$C_L = 50\text{ pF}$	7	9.7	1	11	1	11	ns	
t_{PLZ}				7	9.7	1	11	1	11		
$t_{sk(o)}$			$C_L = 50\text{ pF}$		1**				1	ns	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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noise characteristics, $V_{CC} = 5\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 4)

PARAMETER	SN74AHC245			UNIT
	MIN	TYP	MAX	
$V_{OL(P)}$ Quiet output, maximum dynamic V_{OL}		0.9		V
$V_{OL(V)}$ Quiet output, minimum dynamic V_{OL}		-0.9		V
$V_{OH(V)}$ Quiet output, minimum dynamic V_{OH}		4.3		V
$V_{IH(D)}$ High-level dynamic input voltage		3.5		V
$V_{IL(D)}$ Low-level dynamic input voltage			1.5	V

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

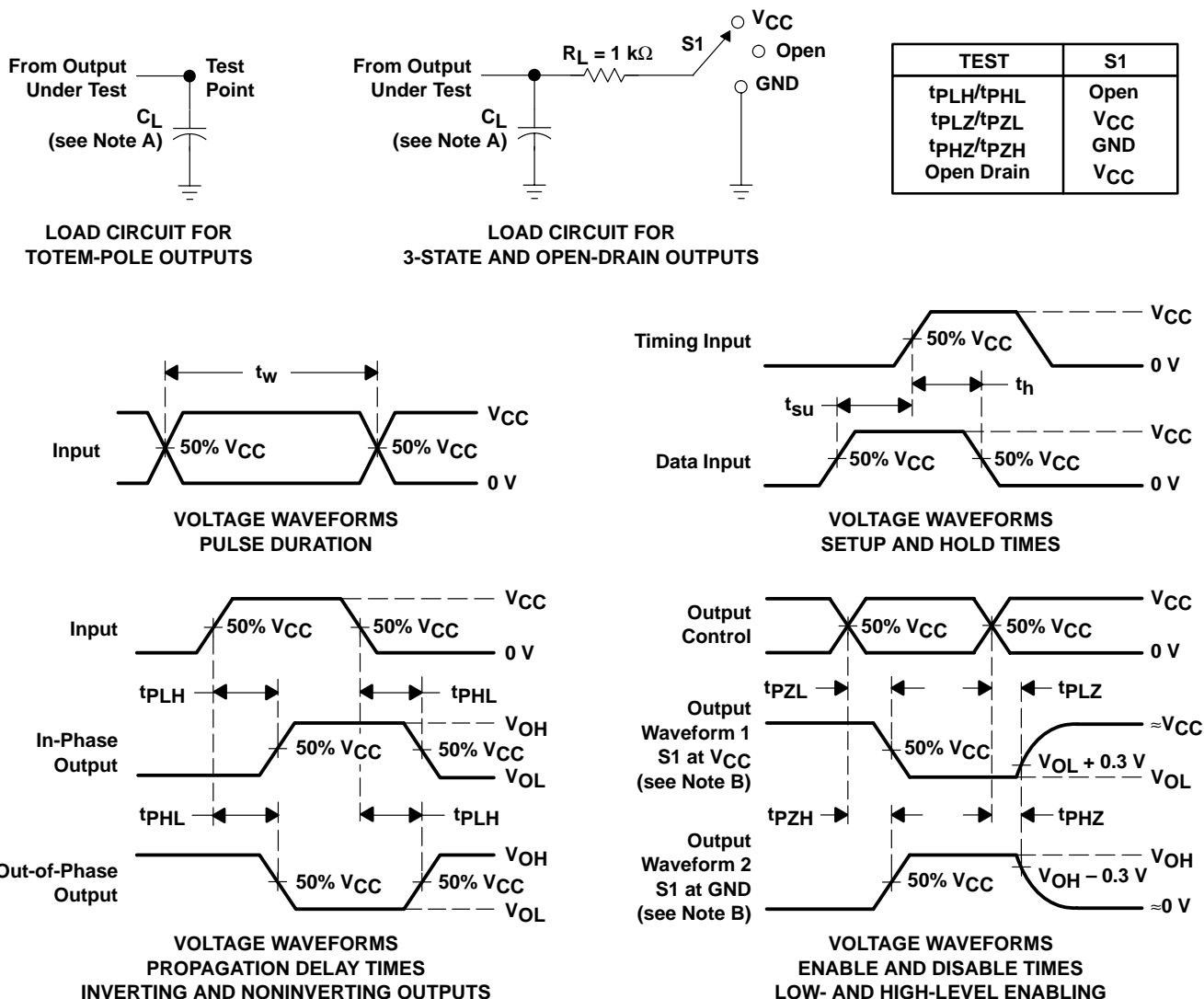
PARAMETER	TEST CONDITIONS	TYP	UNIT
C_{pd} Power dissipation capacitance	No load, $f = 1\text{ MHz}$	14	pF



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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

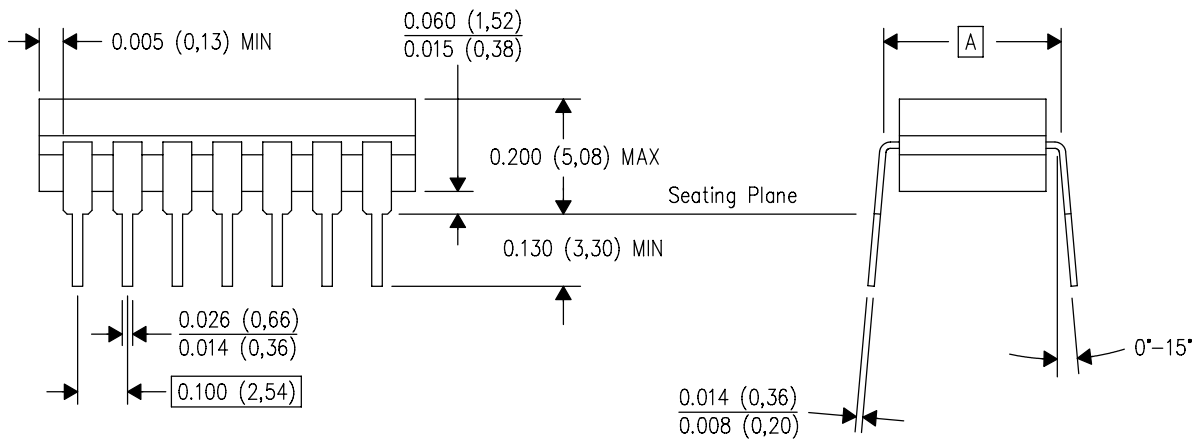
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

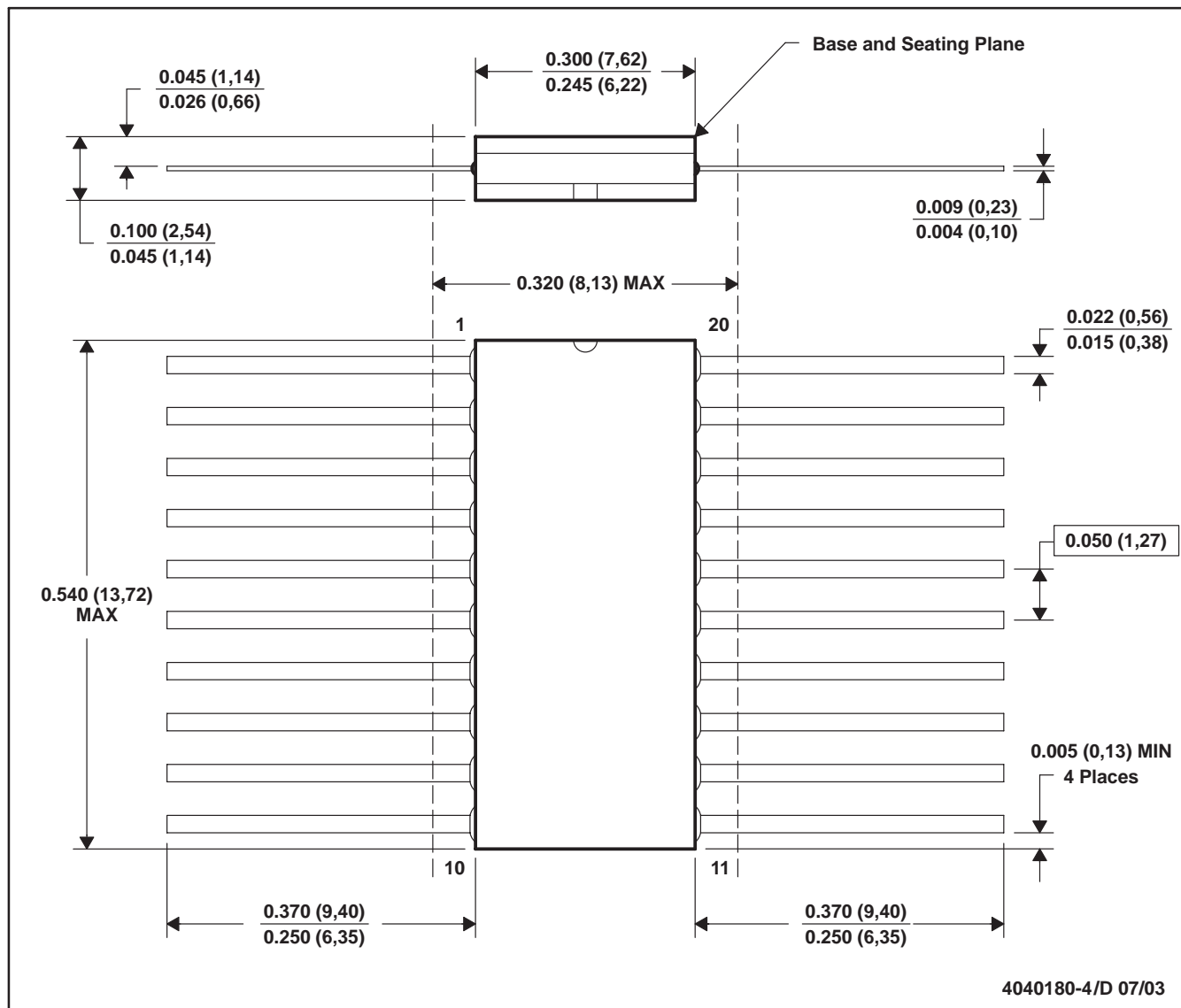


4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK

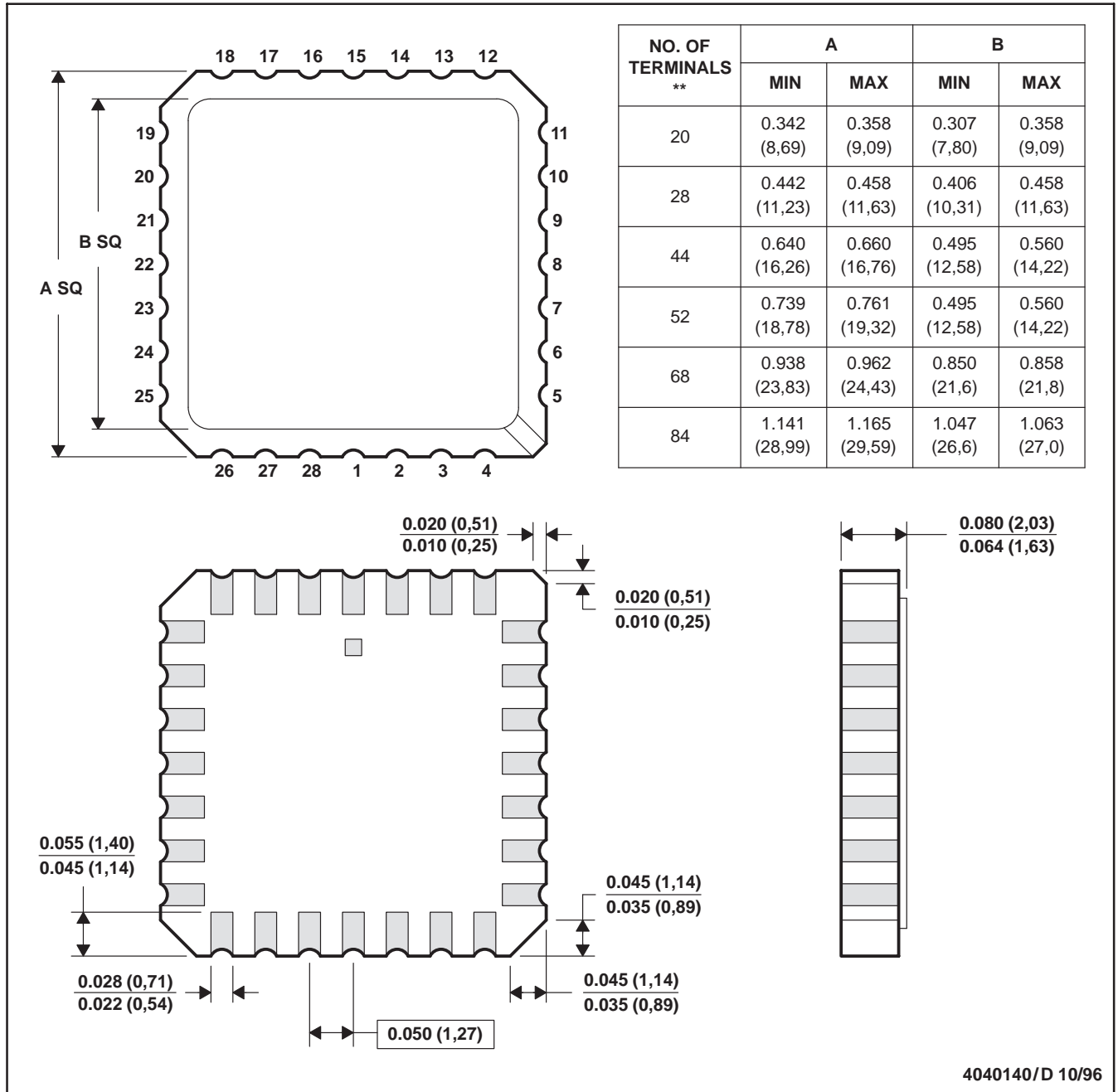


- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. This package can be hermetically sealed with a ceramic lid using glass frit.
 D. Index point is provided on cap for terminal identification only.
 E. Falls within Mil-Std 1835 GDFP2-F20

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

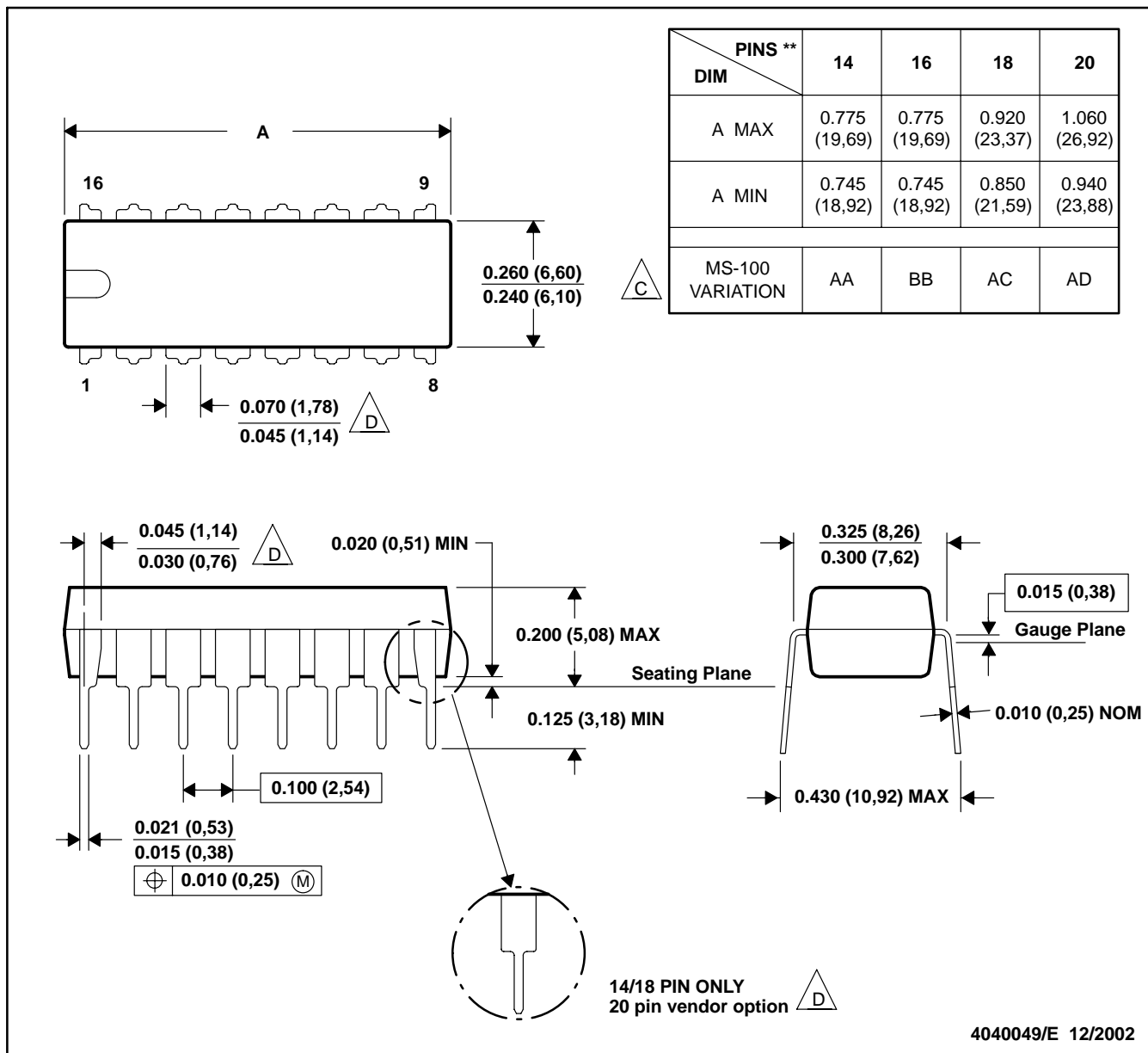


- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 D The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN

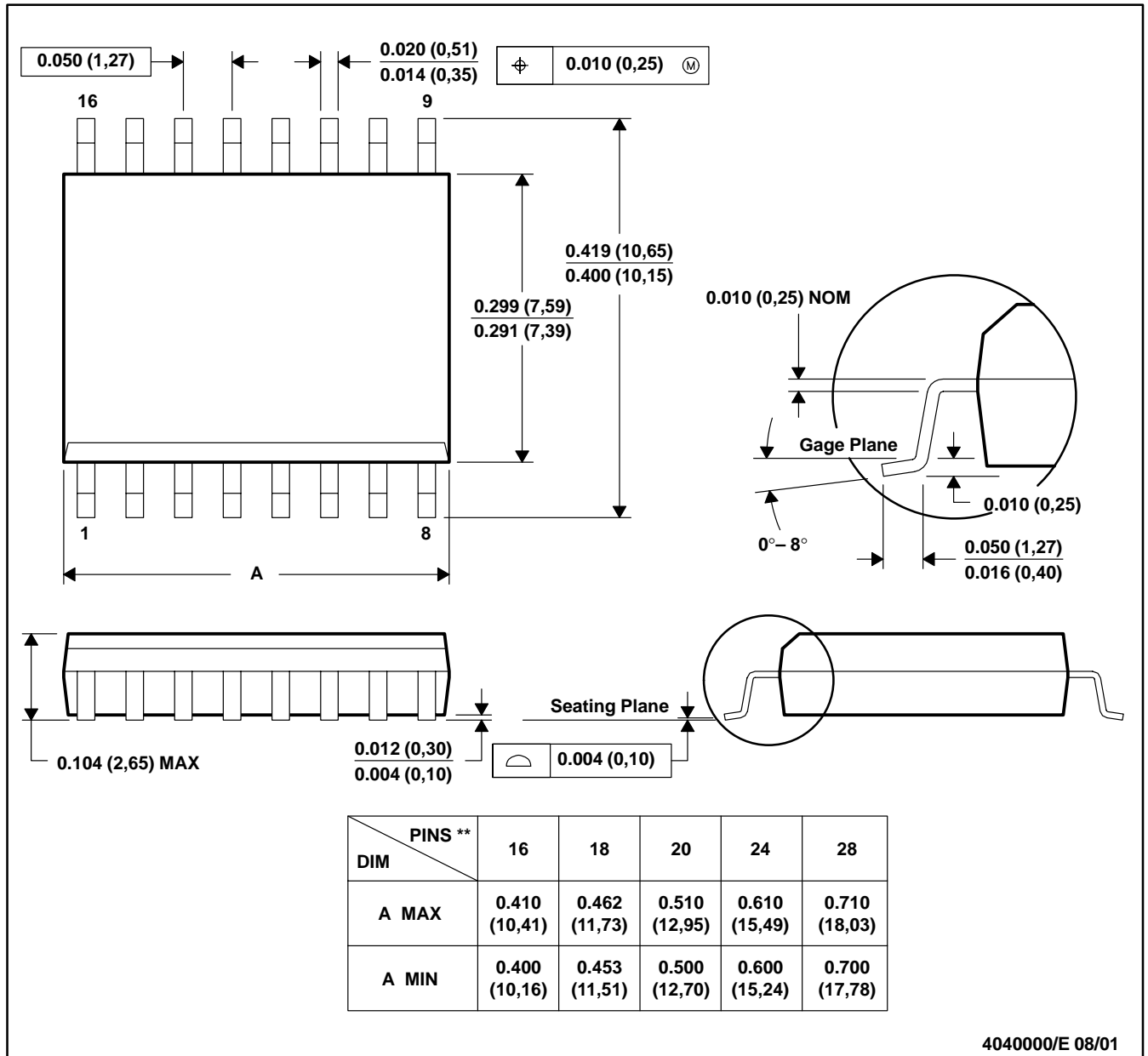


- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



4040000/E 08/01

- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

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